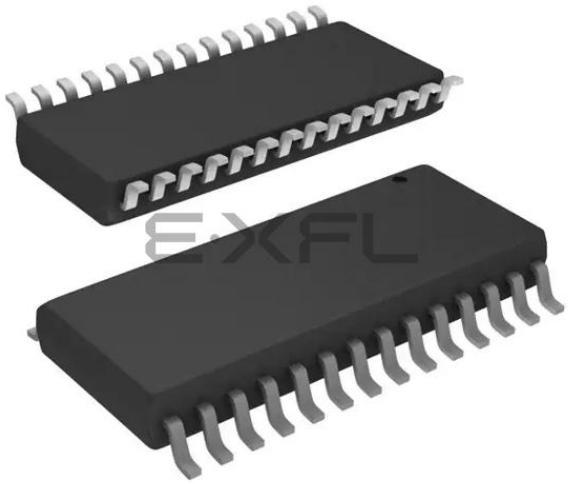

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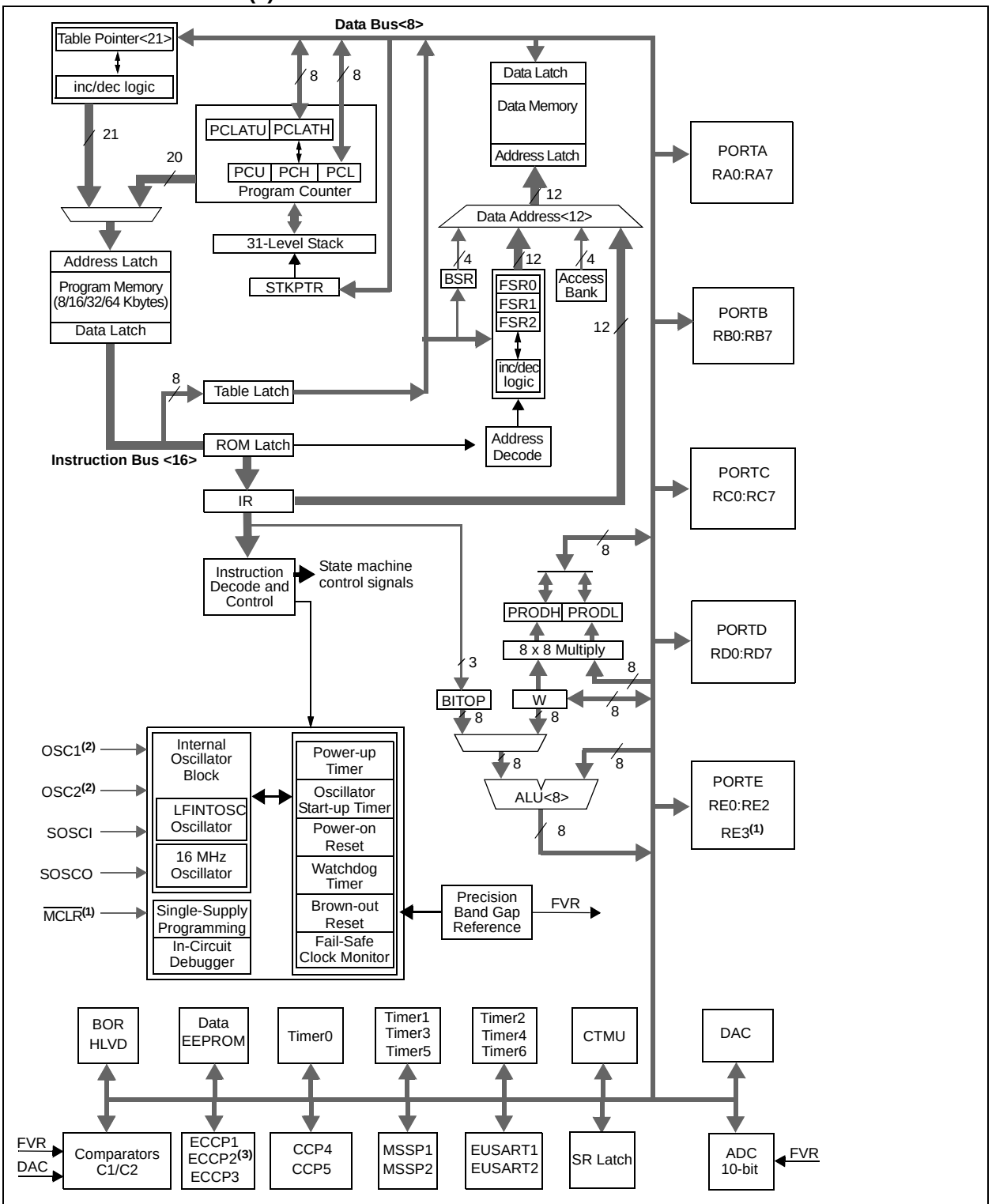
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	8KB (4K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 19x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf23k22t-i-so

FIGURE 1-1: PIC18(L)F2X/4XK22 FAMILY BLOCK DIAGRAM



Note 1: RE3 is only available when $\overline{\text{MCLR}}$ functionality is disabled.

2: OSC1/CLKIN and OSC2/CLKOUT are only available in select oscillator modes and when these pins are not being used as digital I/O. Refer to **Section 2.0 "Oscillator Module (With Fail-Safe Clock Monitor)"** for additional information.

3: Full-Bridge operation for PIC18(L)F4XK22, half-bridge operation for PIC18(L)F2XK22.

3.6 Selective Peripheral Module Control

Idle mode allows users to substantially reduce power consumption by stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what IDLE mode does not provide: the allocation of power resources to the CPU processing with minimal power consumption from the peripherals. PIC18(L)F2X/4XK22 family devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with control bits in the Peripheral Module Disable (PMD) registers. These bits generically named XXXMD are located in control registers PMD0, PMD1 or PMD2.

Setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, power to the control and status registers associated with the peripheral is removed. Writes to these registers have no effect and read values are invalid. Clearing a set PMD bit restores power to the associated control and status registers, thereby setting those registers to their default values.

3.7 Register Definitions: Peripheral Module Disable

REGISTER 3-1: PMD0: PERIPHERAL MODULE DISABLE REGISTER 0

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
UART2MD	UART1MD	TMR6MD	TMR5MD	TMR4MD	TMR3MD	TMR2MD	TMR1MD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **UART2MD:** UART2 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 6 **UART1MD:** UART1 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 5 **TMR6MD:** Timer6 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 4 **TMR5MD:** Timer5 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 3 **TMR4MD:** Timer4 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 2 **TMR3MD:** Timer3 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 1 **TMR2MD:** Timer2 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

bit 0 **TMR1MD:** Timer1 Peripheral Module Disable Control bit
1 = Module is disabled, Clock Source is disconnected, module does not draw digital power
0 = Module is enabled, Clock Source is connected, module draws digital power

8.0 8 x 8 HARDWARE MULTIPLIER

8.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 8-1.

8.2 Operation

Example 8-1 shows the instruction sequence for an 8 x 8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 8-2 shows the sequence to do an 8 x 8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 8-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

```
MOVF    ARG1, W     ;
MULWF   ARG2        ; ARG1 * ARG2 ->
                    ; PRODH:PRODL
```

EXAMPLE 8-2: 8 x 8 SIGNED MULTIPLY ROUTINE

```
MOVF    ARG1, W
MULWF   ARG2        ; ARG1 * ARG2 ->
                    ; PRODH:PRODL
BTFSC   ARG2, SB    ; Test Sign Bit
SUBWF   PRODH, F    ; PRODH = PRODH
                    ;         - ARG1
MOVF    ARG2, W
BTFSC   ARG1, SB    ; Test Sign Bit
SUBWF   PRODH, F    ; PRODH = PRODH
                    ;         - ARG2
```

TABLE 8-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

Routine	Multiply Method	Program Memory (Words)	Cycles (Max)	Time			
				@ 64 MHz	@ 40 MHz	@ 10 MHz	@ 4 MHz
8 x 8 unsigned	Without hardware multiply	13	69	4.3 μs	6.9 μs	27.6 μs	69 μs
	Hardware multiply	1	1	62.5 ns	100 ns	400 ns	1 μs
8 x 8 signed	Without hardware multiply	33	91	5.7 μs	9.1 μs	36.4 μs	91 μs
	Hardware multiply	6	6	375 ns	600 ns	2.4 μs	6 μs
16 x 16 unsigned	Without hardware multiply	21	242	15.1 μs	24.2 μs	96.8 μs	242 μs
	Hardware multiply	28	28	1.8 μs	2.8 μs	11.2 μs	28 μs
16 x 16 signed	Without hardware multiply	52	254	15.9 μs	25.4 μs	102.6 μs	254 μs
	Hardware multiply	35	40	2.5 μs	4.0 μs	16.0 μs	40 μs

REGISTER 9-9: PIE1: PERIPHERAL INTERRUPT ENABLE (FLAG) REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’.

bit 6 **ADIE:** A/D Converter Interrupt Enable bit
1 = Enables the A/D interrupt
0 = Disables the A/D interrupt

bit 5 **RC1IE:** EUSART1 Receive Interrupt Enable bit
1 = Enables the EUSART1 receive interrupt
0 = Disables the EUSART1 receive interrupt

bit 4 **TX1IE:** EUSART1 Transmit Interrupt Enable bit
1 = Enables the EUSART1 transmit interrupt
0 = Disables the EUSART1 transmit interrupt

bit 3 **SSP1IE:** Master Synchronous Serial Port 1 Interrupt Enable bit
1 = Enables the MSSP1 interrupt
0 = Disables the MSSP1 interrupt

bit 2 **CCP1IE:** CCP1 Interrupt Enable bit
1 = Enables the CCP1 interrupt
0 = Disables the CCP1 interrupt

bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
1 = Enables the TMR2 to PR2 match interrupt
0 = Disables the TMR2 to PR2 match interrupt

bit 0 **TMR1IE:** TMR1 Overflow Interrupt Enable bit
1 = Enables the TMR1 overflow interrupt
0 = Disables the TMR1 overflow interrupt

TABLE 10-11: PORTD I/O SUMMARY

Pin Name	Function	TRIS Setting	ANSEL setting	Pin Type	Buffer Type	Description
RD0/SCK2/SCL2/AN20	RD0	0	0	O	DIG	LATD<0> data output; not affected by analog input.
		1	0	I	ST	PORTD<0> data input; disabled when analog input enabled.
	SCK2	0	0	O	DIG	MSSP2 SPI Clock output.
		1	0	I	ST	MSSP2 SPI Clock input.
	SCL2	0	0	O	DIG	MSSP2 I^2C Clock output.
		1	0	I	I^2C	MSSP2 I^2C Clock input.
	AN20	1	1	I	AN	Analog input 20.
RD1/CCP4/SDI2/SDA2/AN21	RD1	0	0	O	DIG	LATD<1> data output; not affected by analog input.
		1	0	I	ST	PORTD<1> data input; disabled when analog input enabled.
	CCP4	0	0	O	DIG	Compare 4 output/PWM 4 output.
		1	0	I	ST	Capture 4 input.
	SDI2	1	0	I	ST	MSSP2 SPI data input.
	SDA2	0	0	O	DIG	MSSP2 I^2C data output.
		1	0	I	I^2C	MSSP2 I^2C data input.
	AN21	1	1	I	AN	Analog input 21.
RD2/P2B/AN22	RD2	0	0	O	DIG	LATD<2> data output; not affected by analog input.
		1	0	I	ST	PORTD<2> data input; disabled when analog input enabled.
	P2B(1)	0	0	O	DIG	Enhanced CCP2 PWM output 2.
	AN22	1	1	I	AN	Analog input 22.
RD3/P2C/$\overline{SS2}$/AN23	RD3	0	0	O	DIG	LATD<3> data output; not affected by analog input.
		1	0	I	ST	PORTD<3> data input; disabled when analog input enabled.
	P2C	0	0	O	DIG	Enhanced CCP2 PWM output 4.
	$\overline{SS2}$	1	0	I	TTL	MSSP2 SPI slave select input.
	AN23	1	1	I	AN	Analog input 23.
RD4/P2D/SDO2/AN24	RD4	0	0	O	DIG	LATD<4> data output; not affected by analog input.
		1	0	I	ST	PORTD<4> data input; disabled when analog input enabled.
	P2D	0	0	O	DIG	Enhanced CCP2 PWM output 3.
	SDO2	0	0	O	DIG	MSSP2 SPI data output.
	AN24	1	1	I	AN	Analog input 24.
RD5/P1B/AN25	RD5	0	0	O	DIG	LATD<5> data output; not affected by analog input.
		1	0	I	ST	PORTD<5> data input; disabled when analog input enabled.
	P1B	0	0	O	DIG	Enhanced CCP1 PWM output 2.
	AN25	1	1	I	AN	Analog input 25.

Legend: AN = Analog input or output; TTL = TTL compatible input; HV = High Voltage; OD = Open Drain; XTAL = Crystal; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C.

Note 1: Default pin assignment for P2B, T3CKI, CCP3 and CCP2 when Configuration bits PB2MX, T3CMX, CCP3MX and CCP2MX are set.

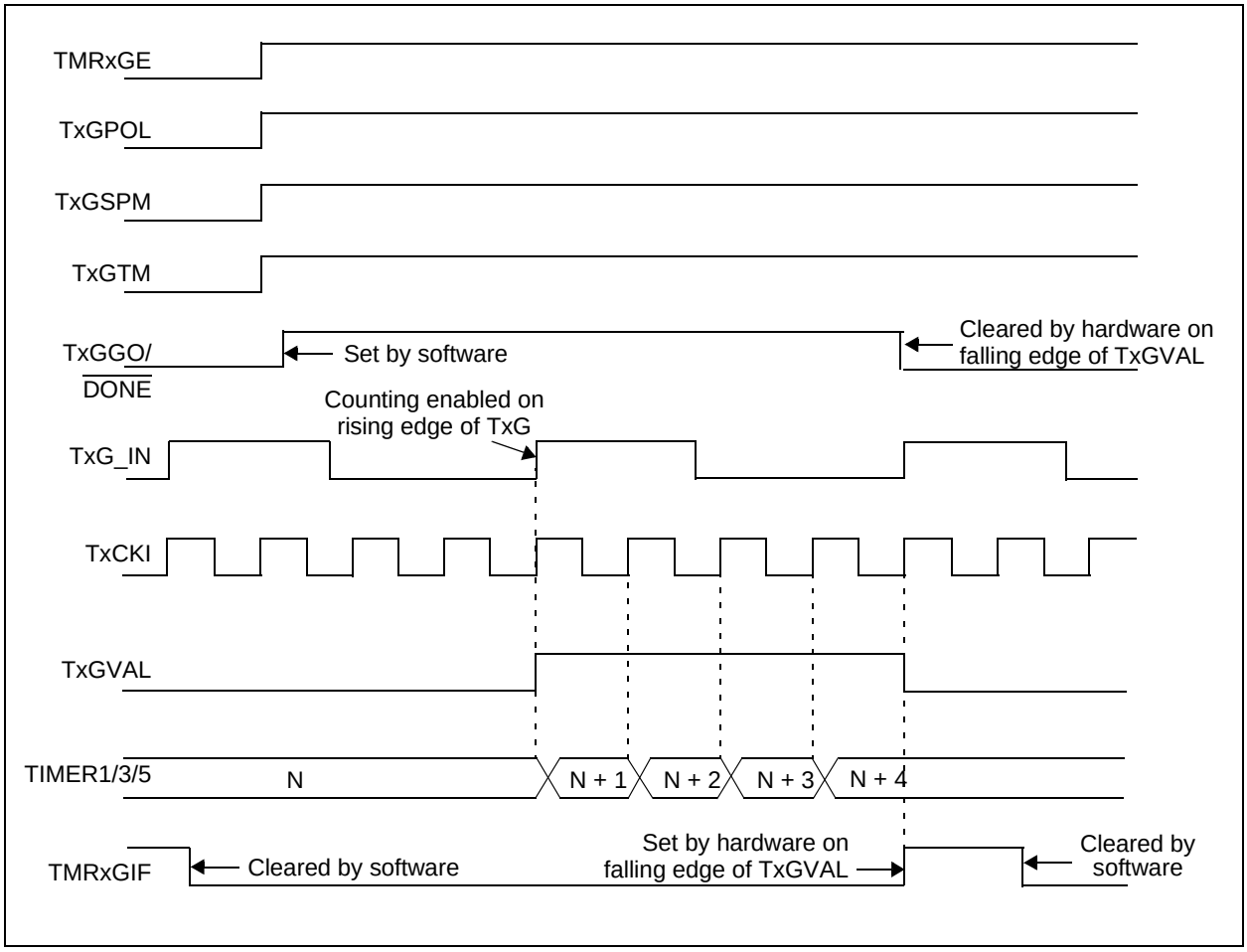
TABLE 10-14: PORTE I/O SUMMARY

Pin	Function	TRIS Setting	ANSEL Setting	Pin Type	Buffer Type	Description
RE0/P3A/CCP3/AN5	RE0	0	0	O	DIG	LATE<0> data output; not affected by analog input.
		1	0	I	ST	PORTE<0> data input; disabled when analog input enabled.
	P3A(1)	0	0	O	DIG	Enhanced CCP3 PWM output.
	CCP3(1)	0	0	O	DIG	Compare 3 output/PWM 3 output.
		1	0	I	ST	Capture 3 input.
	AN5	1	1	I	AN	Analog input 5.
RE1/P3B/AN6	RE1	0	0	O	DIG	LATE<1> data output; not affected by analog input.
		1	0	I	ST	PORTE<1> data input; disabled when analog input enabled.
	P3B	0	0	O	DIG	Enhanced CCP3 PWM output.
	AN6	1	1	I	AN	Analog input 6.
RE2/CCP5/AN7	RE2	0	0	O	DIG	LATE<2> data output; not affected by analog input.
		1	0	I	ST	PORTE<2> data input; disabled when analog input enabled.
	CCP5	0	0	O	DIG	Compare 5 output/PWM 5 output.
		1	0	I	ST	Capture 5 input.
	AN7	1	1	I	AN	Analog input 7.
RE3/VPP/$\overline{\text{MCLR}}$	RE3	—	—	I	ST	PORTE<3> data input; enabled when Configuration bit MCLRE = 0.
	VPP	—	—	P	AN	Programming voltage input; always available
	$\overline{\text{MCLR}}$	—	—	I	ST	Active-low Master Clear (device Reset) input; enabled when configuration bit MCLRE = 1.

Legend: AN = Analog input or output; TTL = TTL compatible input; HV = High Voltage; OD = Open Drain; XTAL = Crystal; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C.

Note 1: Alternate pin assignment for P3A/CCP3 when Configuration bit CCP3MX is clear.

FIGURE 12-7: TIMER1/3/5 GATE SINGLE-PULSE AND TOGGLE COMBINED MODE



12.12 Peripheral Module Disable

When a peripheral module is not used or inactive, the module can be disabled by setting the Module Disable bit in the PMD registers. This will reduce power consumption to an absolute minimum. Setting the PMD bits holds the module in Reset and disconnects the module's clock source. The Module Disable bits for Timer1 (TMR1MD), Timer3 (TMR3MD) and Timer5 (TMR5MD) are in the PMD0 Register. See **Section 3.0 "Power-Managed Modes"** for more information.

15.4.5 START CONDITION

The I^2C specification defines a Start condition as a transition of SDAx from a high-to -low state while SCLx line is high. A Start condition is always generated by the master and signifies the transition of the bus from an Idle to an active state. Figure 15-12 shows wave forms for Start and Stop conditions.

A bus collision can occur on a Start condition if the module samples the SDAx line low before asserting it low. This does not conform to the I^2C specification that states no bus collision can occur on a Start.

15.4.6 STOP CONDITION

A Stop condition is a transition of the SDAx line from a low-to-high state while the SCLx line is high.

Note:	At least one SCLx low time must appear before a Stop is valid, therefore, if the SDAx line goes low then high again while the SCLx line stays high, only the Start condition is detected.

15.4.7 RESTART CONDITION

A Restart is valid any time that a Stop would be valid. A master can issue a Restart if it wishes to hold the bus after terminating the current transfer. A Restart has the same effect on the slave that a Start would, resetting all slave logic and preparing it to clock in an address. The master may want to address the same or another slave. Figure 15-13 shows the wave form for a Restart condition.

In 10-bit Addressing Slave mode a Restart is required for the master to clock data out of the addressed slave. Once a slave has been fully addressed, matching both high and low address bytes, the master can issue a Restart and the high address byte with the R/$\overline{W}$ bit set. The slave logic will then hold the clock and prepare to clock out data.

After a full match with R/$\overline{W}$ clear in 10-bit mode, a prior match flag is set and maintained. Until a Stop condition, a high address with R/$\overline{W}$ clear, or high address match fails.

15.4.8 START/STOP CONDITION INTERRUPT MASKING

The SCIE and PCIE bits of the SSPxCON3 register can enable the generation of an interrupt in Slave modes that do not typically support this function. Slave modes where interrupt on Start and Stop detect are already enabled, these bits will have no effect.

FIGURE 15-12: I^2C START AND STOP CONDITIONS

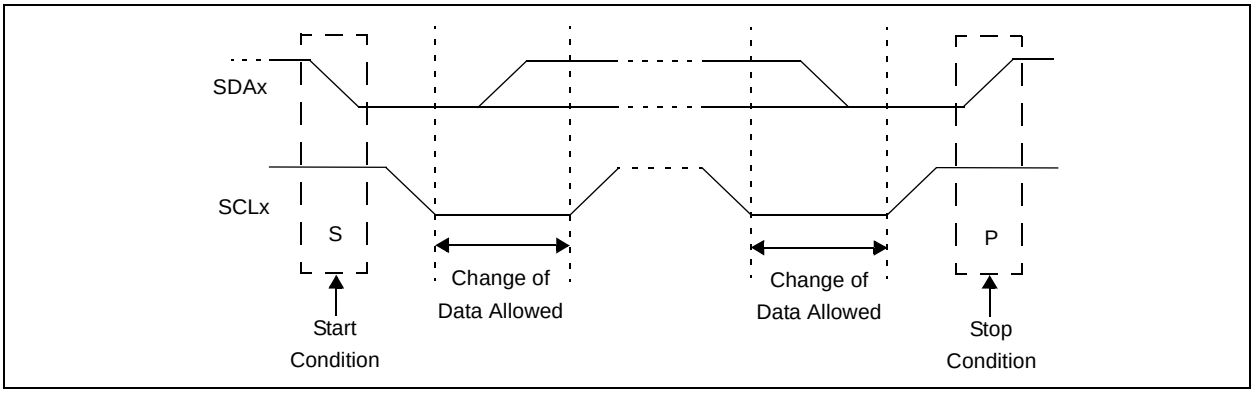
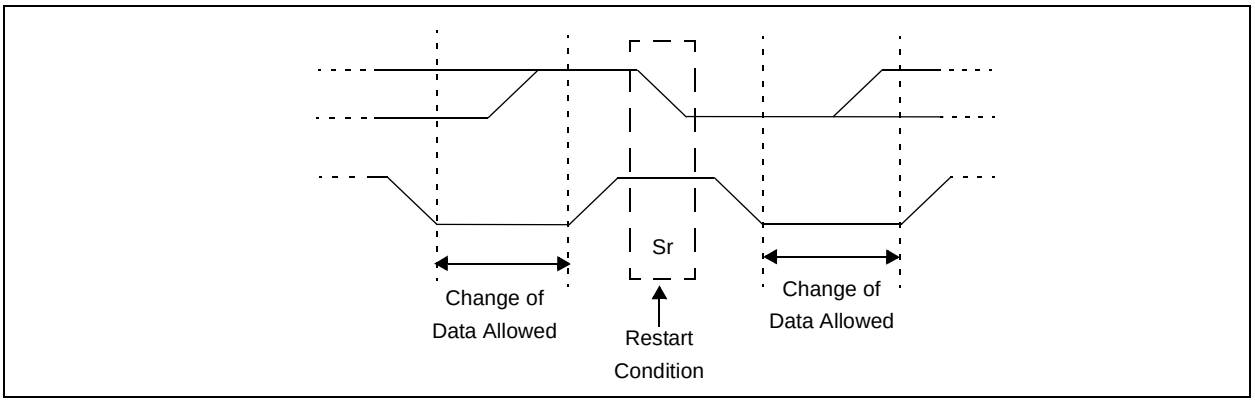


FIGURE 15-13: I^2C RESTART CONDITION



16.4.4 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. A Break character consists of a Start bit, followed by 12 '0' bits and a Stop bit.

To send a Break character, set the SENDB and TXEN bits of the TXSTAx register. The Break character transmission is then initiated by a write to the TXREGx. The value of data written to TXREGx will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

The TRMT bit of the TXSTAx register indicates when the transmit operation is active or Idle, just as it does during normal transmission. See Figure 16-9 for the timing of the Break character sequence.

16.4.4.1 Break and Sync Transmit Sequence

The following sequence will start a message frame header made up of a Break, followed by an auto-baud Sync byte. This sequence is typical of a LIN bus master.

1. Configure the EUSART for the desired mode.
2. Set the TXEN and SENDB bits to enable the Break sequence.
3. Load the TXREGx with a dummy character to initiate transmission (the value is ignored).
4. Write '55h' to TXREGx to load the Sync character into the transmit FIFO buffer.
5. After the Break has been sent, the SENDB bit is reset by hardware and the Sync character is then transmitted.

When the TXREGx becomes empty, as indicated by the TXxIF, the next data byte can be written to TXREGx.

16.4.5 RECEIVING A BREAK CHARACTER

The Enhanced EUSART module can receive a Break character in two ways.

The first method to detect a Break character uses the FERR bit of the RCSTAx register and the Received data as indicated by RCREGx. The Baud Rate Generator is assumed to have been initialized to the expected baud rate.

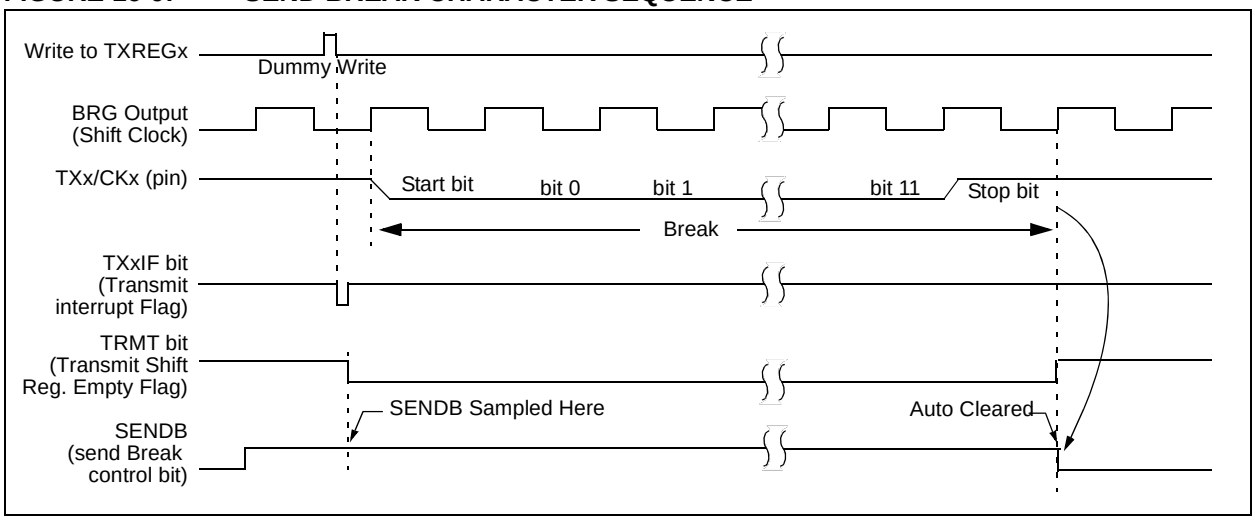
A Break character has been received when;

- RCxIF bit is set
- FERR bit is set
- RCREGx = 00h

The second method uses the Auto-Wake-up feature described in **Section 16.4.3 "Auto-Wake-up on Break"**. By enabling this feature, the EUSART will sample the next two transitions on RXx/DTx, cause an RCxIF interrupt, and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Detect feature. For both methods, the user can set the ABDEN bit of the BAUDCONx register before placing the EUSART in Sleep mode.

FIGURE 16-9: SEND BREAK CHARACTER SEQUENCE



REGISTER 17-3: ADCON2: A/D CONTROL REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	—	ACQT<2:0>			ADCS<2:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **ADFM:** A/D Conversion Result Format Select bit
1 = Right justified
0 = Left justified

bit 6 **Unimplemented:** Read as ‘0’

bit 5-3 **ACQT<2:0>:** A/D Acquisition time select bits. Acquisition time is the duration that the A/D charge holding capacitor remains connected to A/D channel from the instant the GO/DONE bit is set until conversions begins.
000 = 0**(1)**
001 = 2 TAD
010 = 4 TAD
011 = 6 TAD
100 = 8 TAD
101 = 12 TAD
110 = 16 TAD
111 = 20 TAD

bit 2-0 **ADCS<2:0>:** A/D Conversion Clock Select bits
000 = FOSC/2
001 = FOSC/8
010 = FOSC/32
011 = FRC**(1)** (clock derived from a dedicated internal oscillator = 600 kHz nominal)
100 = FOSC/4
101 = FOSC/16
110 = FOSC/64
111 = FRC**(1)** (clock derived from a dedicated internal oscillator = 600 kHz nominal)

Note 1: When the A/D clock source is selected as FRC then the start of conversion is delayed by one instruction cycle after the GO/DONE bit is set to allow the SLEEP instruction to be executed.

REGISTER 20-2: SRCON1: SR LATCH CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SRSPE	SRSCKE	SRSC2E	SRSC1E	SRRPE	SRRCKE	SRRC2E	SRRC1E
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	C = Clearable only bit
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SRSPE:** SR Latch Peripheral Set Enable bit
1 = SRI pin status sets SR latch
0 = SRI pin status has no effect on SR latch

bit 6 **SRSCKE:** SR Latch Set Clock Enable bit
1 = Set input of SR latch is pulsed with DIVSRCLK
0 = Set input of SR latch is not pulsed with DIVSRCLK

bit 5 **SRSC2E:** SR Latch C2 Set Enable bit
1 = C2 Comparator output sets SR latch
0 = C2 Comparator output has no effect on SR latch

bit 4 **SRSC1E:** SR Latch C1 Set Enable bit
1 = C1 Comparator output sets SR latch
0 = C1 Comparator output has no effect on SR latch

bit 3 **SRRPE:** SR Latch Peripheral Reset Enable bit
1 = SRI pin resets SR latch
0 = SRI pin has no effect on SR latch

bit 2 **SRRCKE:** SR Latch Reset Clock Enable bit
1 = Reset input of SR latch is pulsed with DIVSRCLK
0 = Reset input of SR latch is not pulsed with DIVSRCLK

bit 1 **SRRC2E:** SR Latch C2 Reset Enable bit
1 = C2 Comparator output resets SR latch
0 = C2 Comparator output has no effect on SR latch

bit 0 **SRRC1E:** SR Latch C1 Reset Enable bit
1 = C1 Comparator output resets SR latch
0 = C1 Comparator output has no effect on SR latch

TABLE 20-2: REGISTERS ASSOCIATED WITH THE SR LATCH

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
SRCON0	SRLEN	SRCLK<2:0>			SRQEN	SRNQEN	SRPS	SRPR	329
SRCON1	SRSPE	SRSCKE	SRSC2E	SRSC1E	SRRPE	SRRCKE	SRRC2E	SRRC1E	330
TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	151
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	151
WPUB	WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0	152

Legend: Shaded bits are not used with this module.

CPFSGT **Compare f with W, skip if f > W**

Syntax: CPFSGT f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: (f) – (W),
skip if (f) > (W)
(unsigned comparison)

Status Affected: None

Encoding:

0110	010a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of the W by performing an unsigned subtraction.
If the contents of 'f' are greater than the contents of WREG, then the fetched instruction is discarded and a NOP is executed instead, making this a 2-cycle instruction.
If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE      CPFSGT REG, 0
NGREATER  :
GREATER   :
```

Before Instruction
PC = Address (HERE)
W = ?
After Instruction
If REG > W;
PC = Address (GREATER)
If REG ≤ W;
PC = Address (NGREATER)

CPFSLT **Compare f with W, skip if f < W**

Syntax: CPFSLT f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: (f) – (W),
skip if (f) < (W)
(unsigned comparison)

Status Affected: None

Encoding:

0110	000a	ffff	ffff

Description: Compares the contents of data memory location 'f' to the contents of W by performing an unsigned subtraction.
If the contents of 'f' are less than the contents of W, then the fetched instruction is discarded and a NOP is executed instead, making this a 2-cycle instruction.
If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the GPR bank.

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    CPFSLT REG, 1
NLESS   :
LESS    :
```

Before Instruction
PC = Address (HERE)
W = ?
After Instruction
If REG < W;
PC = Address (LESS)
If REG ≥ W;
PC = Address (NLESS)

TSTFSZ **Test f, skip if 0**

Syntax: TSTFSZ f {,a}

Operands: $0 \le f \le 255$
$a \in [0,1]$

Operation: skip if f = 0

Status Affected: None

Encoding:

0110	011a	ffff	ffff

Description: If 'f' = 0, the next instruction fetched during the current instruction execution is discarded and a NOP is executed, making this a 2-cycle instruction.
If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See **Section 25.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	No operation

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    TSTFSZ  CNT, 1
NZERO   :
ZERO    :
```
Before Instruction
PC = Address (HERE)
After Instruction
If CNT = 00h,
PC = Address (ZERO)
If CNT ≠ 00h,
PC = Address (NZERO)

XORLW **Exclusive OR literal with W**

Syntax: XORLW k

Operands: $0 \le k \le 255$

Operation: (W) .XOR. k → W

Status Affected: N, Z

Encoding:

0000	1010	kkkk	kkkk

Description: The contents of W are XORed with the 8-bit literal 'k'. The result is placed in W.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	Write to W

Example:
```
XORLW   0AFh
```
Before Instruction
W = B5h
After Instruction
W = 1Ah

26.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

26.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®

27.6 DC Characteristics: Primary Idle Supply Current, PIC18(L)F2X/4XK22

PIC18LF2X/4XK22		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C					
PIC18F2X/4XK22		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C					
Param No.	**Device Characteristics**	**Typ**	**Max**	**Units**	**Conditions**		
D100	Supply Current (IDD)[1],[2]	0.030	0.050	mA	-40°C to +125°C	VDD = 1.8V	Fosc = 1 MHz (**PRI_IDLE** mode, ECM source)
D101		0.045	0.065	mA	-40°C to +125°C	VDD = 3.0V	
D102		0.06	0.12	mA	-40°C to +125°C	VDD = 2.3V	Fosc = 1 MHz (**PRI_IDLE** mode, ECM source)
D103		0.08	0.15	mA	-40°C to +125°C	VDD = 3.0V	
D104		0.13	0.20	mA	-40°C to +125°C	VDD = 5.0V	
D105		0.45	0.8	mA	-40°C to +125°C	VDD = 1.8V	Fosc = 20 MHz (**PRI_IDLE** mode, ECH source)
D106		0.70	1.0	mA	-40°C to +125°C	VDD = 3.0V	
D107		0.55	0.8	mA	-40°C to +125°C	VDD = 2.3V	Fosc = 20 MHz (**PRI_IDLE** mode, ECH source)
D108		0.75	1.0	mA	-40°C to +125°C	VDD = 3.0V	
D109		0.90	1.2	mA	-40°C to +125°C	VDD = 5.0V	
D110		2.25	3.0	mA	-40°C to +125°C	VDD = 3.0V	Fosc = 64 MHz (**PRI_IDLE** mode, ECH source)
D111		2.25	3.0	mA	-40°C to +125°C	VDD = 3.0V	Fosc = 64 MHz (**PRI_IDLE** mode, ECH source)
D112		2.60	3.5	mA	-40°C to +125°C	VDD = 5.0V	
D113		0.35	0.6	mA	-40°C to +125°C	VDD = 1.8V	Fosc = 4 MHz 16 MHz Internal (**PRI_IDLE** mode, ECM + PLL source)
D114		0.55	0.8	mA	-40°C to +125°C	VDD = 3.0V	
D115		0.45	0.6	mA	-40°C to +125°C	VDD = 2.3V	Fosc = 4 MHz 16 MHz Internal (**PRI_IDLE** mode, ECM + PLL source)
D116		0.60	0.9	mA	-40°C to +125°C	VDD = 3.0V	
D117		0.70	1.0	mA	-40°C to +125°C	VDD = 5.0V	
D118		2.2	3.0	mA	-40°C to +125°C	VDD = 3.0V	Fosc = 16 MHz 64 MHz Internal (**PRI_IDLE** mode, ECH + PLL source)
D119		2.2	3.0	mA	-40°C to +125°C	VDD = 3.0V	Fosc = 16 MHz 64 MHz Internal (**PRI_IDLE** mode, ECH + PLL source)
D120		2.5	3.5	mA	-40°C to +125°C	VDD = 5.0V	

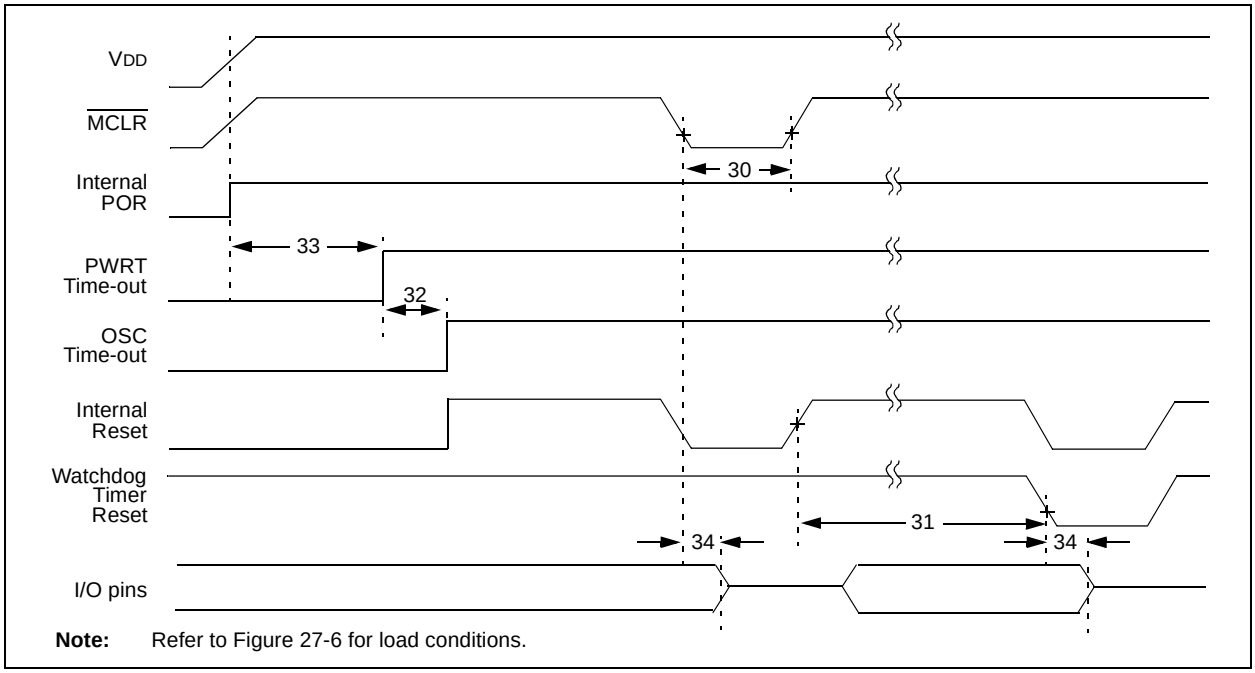
Note 1: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

Test condition: All Peripheral Module Control bits in PMD0, PMD1 and PMD2 set to '1'.

2: The test conditions for all IDD measurements in active operation mode are:

All I/O pins set as outputs driven to Vss;
MCLR = VDD;
OSC1 = external square wave, from rail-to-rail (PRI_RUN and PRI_IDLE only).

FIGURE 27-9: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



Note: Refer to Figure 27-6 for load conditions.

FIGURE 27-10: BROWN-OUT RESET TIMING

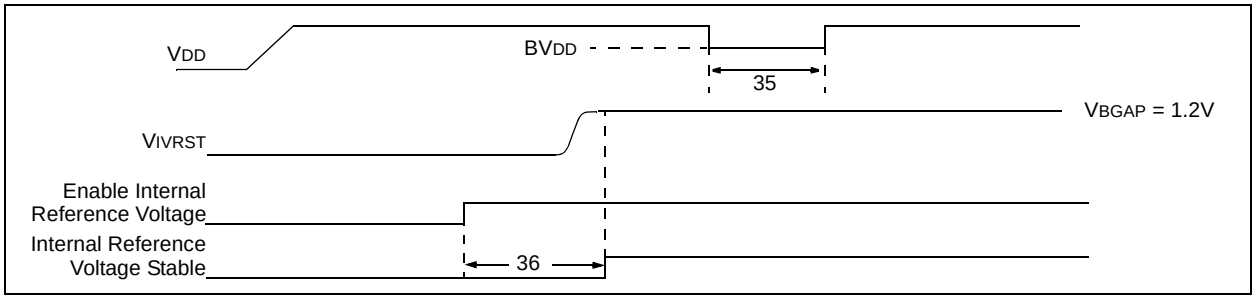


FIGURE 27-15: EXAMPLE SPI SLAVE MODE TIMING (CKE = 0)

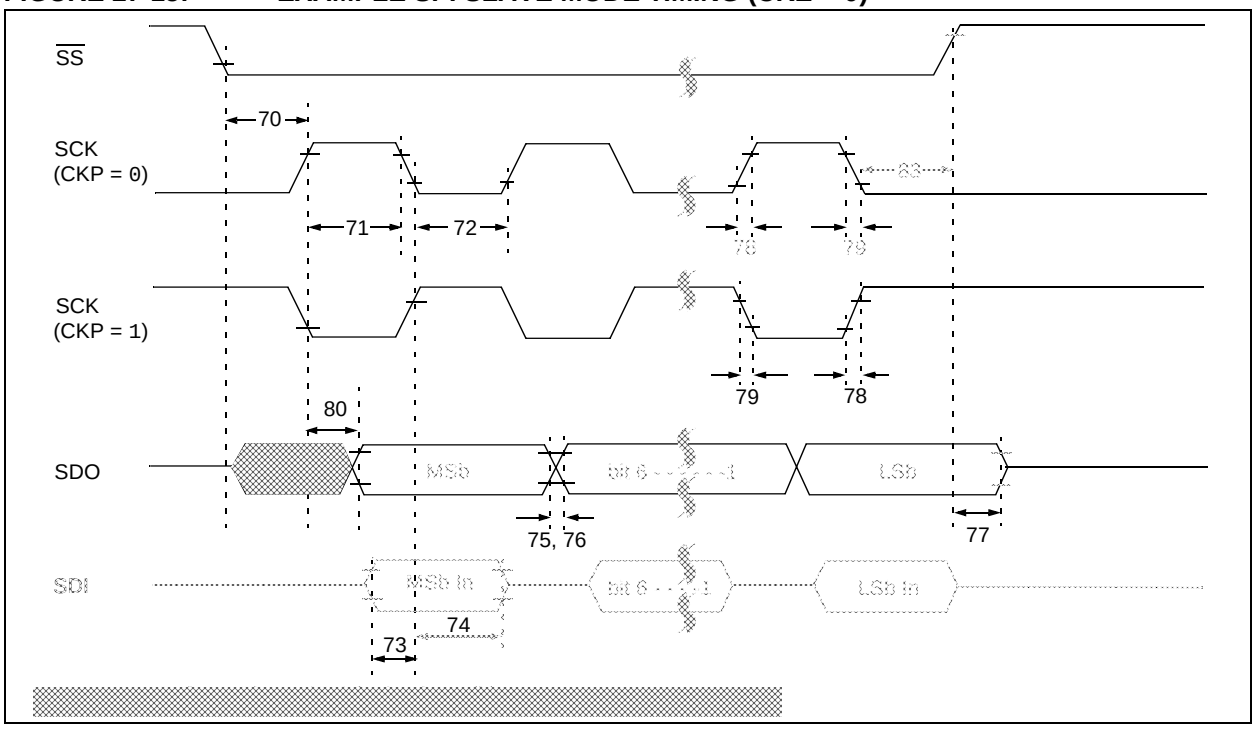


FIGURE 27-16: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1)

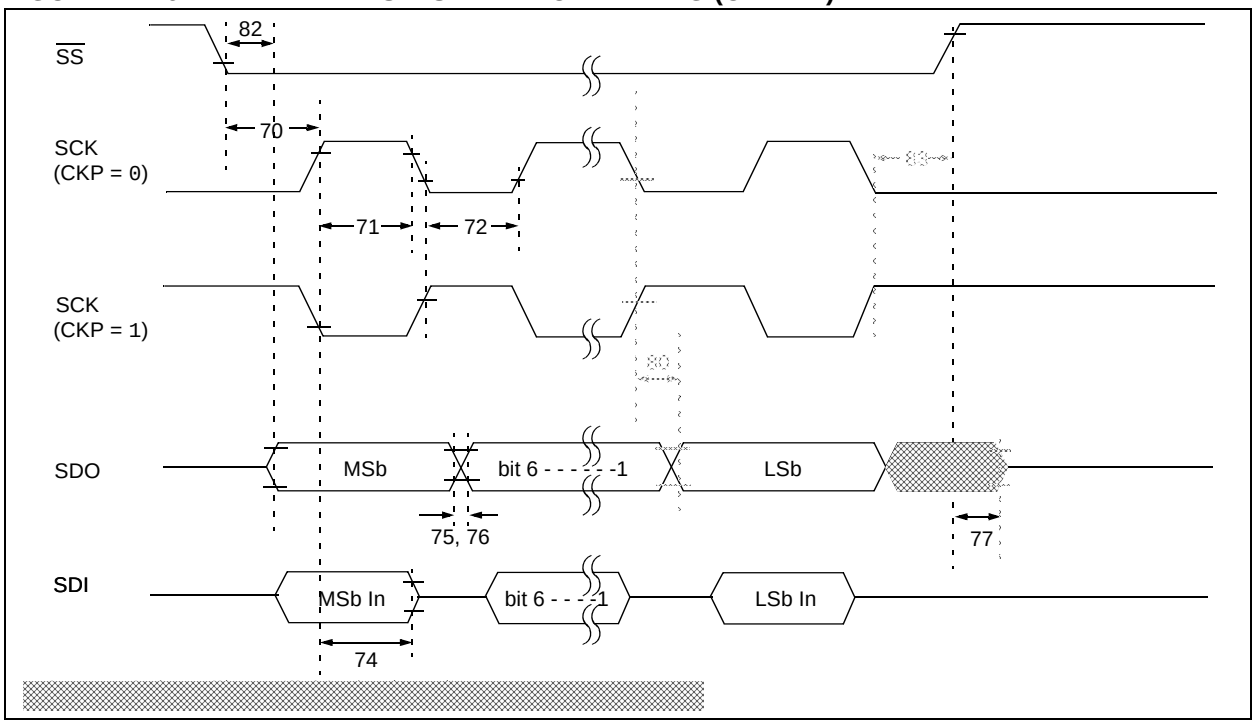
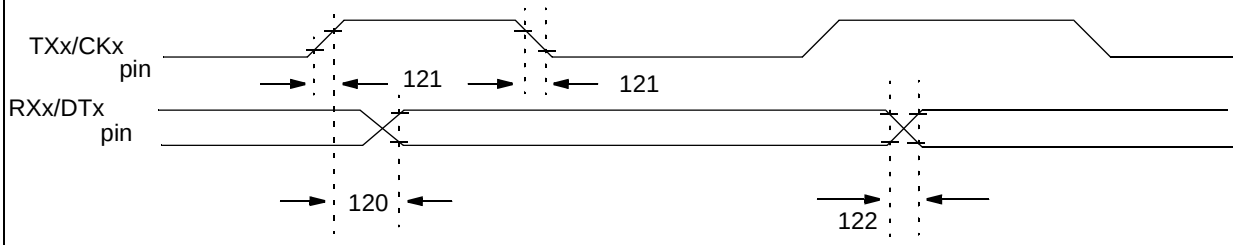


FIGURE 27-21: EUSART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

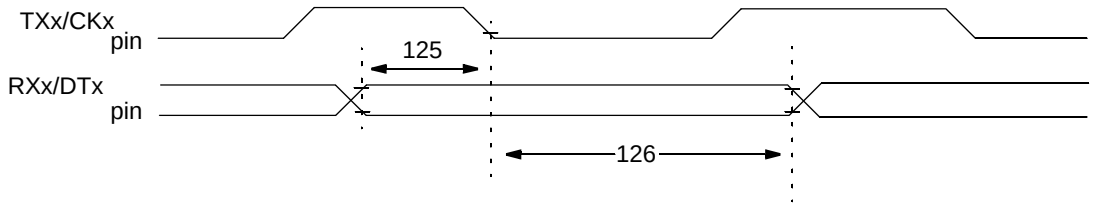


Note: Refer to Figure 27-6 for load conditions.

TABLE 27-19: EUSART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
120	TckH2dtV	SYNC XMIT (MASTER & SLAVE) Clock High to Data Out Valid	—	40	ns	
121	Tckrf	Clock Out Rise Time and Fall Time (Master mode)	—	20	ns	
122	Tdtrf	Data Out Rise Time and Fall Time	—	20	ns	

FIGURE 27-22: EUSART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING



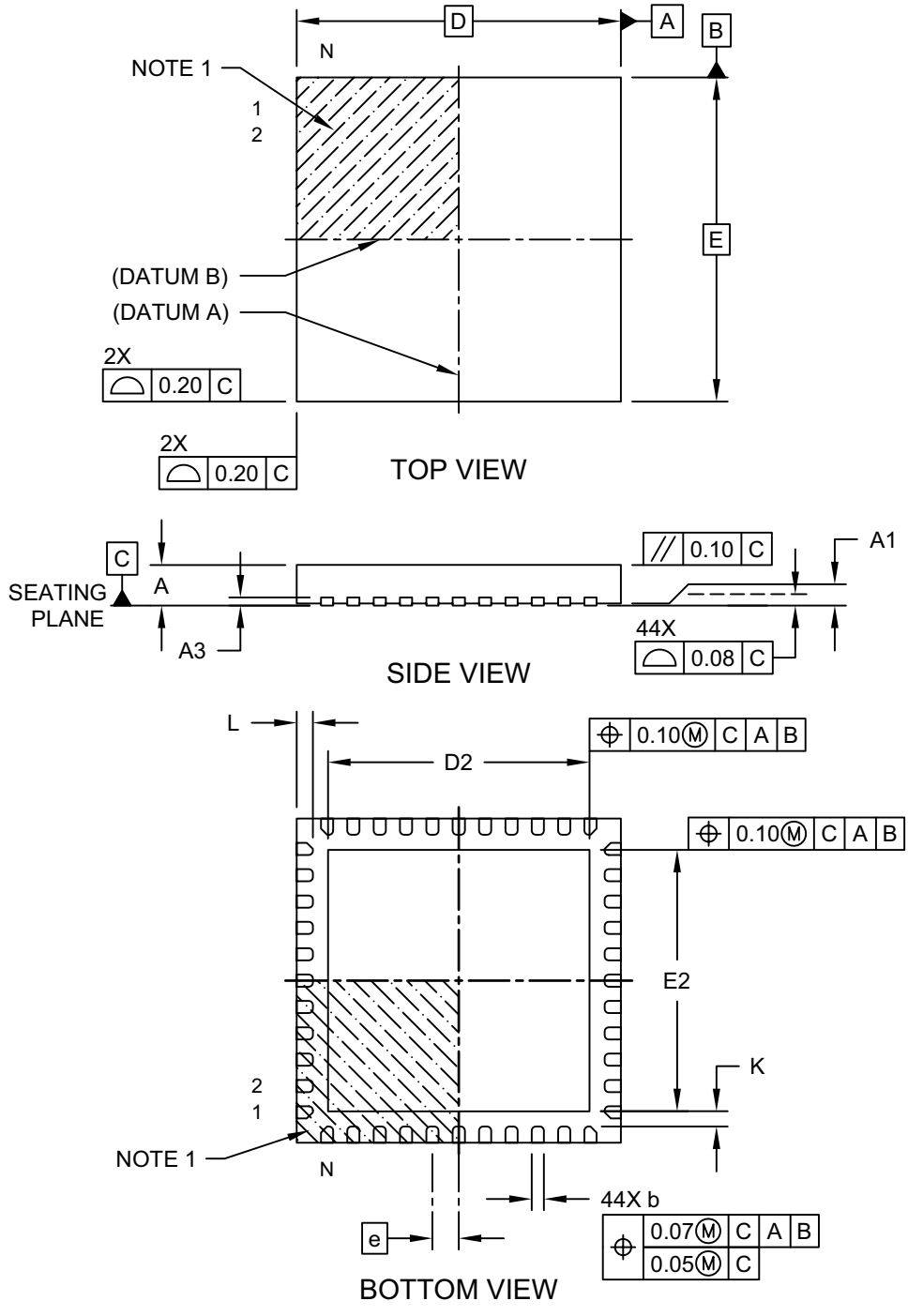
Note: Refer to Figure 27-6 for load conditions.

TABLE 27-20: EUSART SYNCHRONOUS RECEIVE REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
125	TdtV2ckl	SYNC RCV (MASTER & SLAVE) Data Setup before CK ↓ (DT setup time)	10	—	ns	
126	TckL2dtl	Data Hold after CK ↓ (DT hold time)	15	—	ns	

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN or VQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-103D Sheet 1 of 2